

**Product Summary**

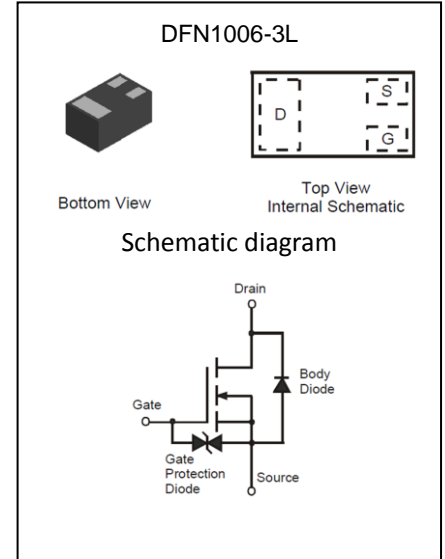
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
60V	1.2Ω@10V	0.41A
	1.3Ω@4.5V	

**Feature**

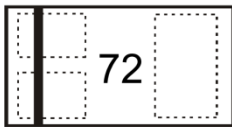
- Low On-Resistance
- Low Threshold Voltage
- Fast Switching Speed
- ESD Protected Gate

**Application**

- Load Switch
- Portable Applications
- Power Management Functions



**MARKING:**



Top View  
Bar Denotes Gate and Source Side

**Package Marking and Ordering Information**

Device Marking	Device	OUTLINE	Device Package	Reel Size	Reel (PCS)	Per Carton (PCS)
72	TK2N7002KDF	TAPING	DFN1006-3L	7inch	10000	400000

**ABSOLUTE MAXIMUM RATINGS ( $T_a=25^{\circ}C$  unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current	$I_D$	$T_a=25^{\circ}C$	0.41
		$T_a=85^{\circ}C$	0.30
Pulsed Drain Current	$I_{DM}$	1.2	A
Power Dissipation	$P_D$	0.1	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	1250	$^{\circ}C/W$
Storage Temperature	$T_{STG}$	-55~ +150	$^{\circ}C$

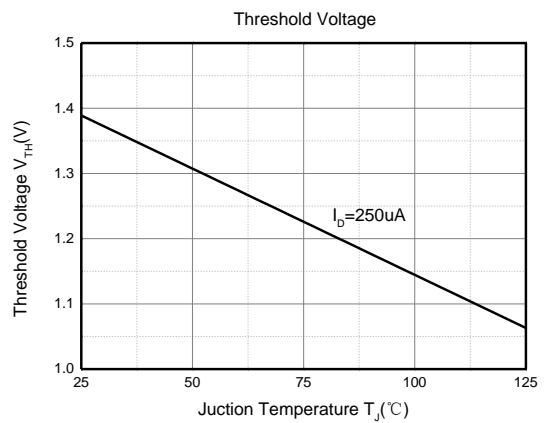
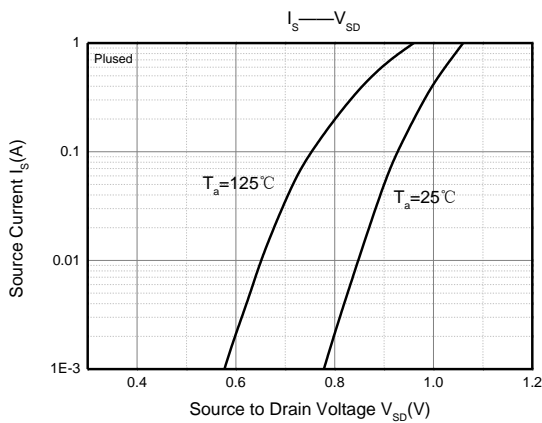
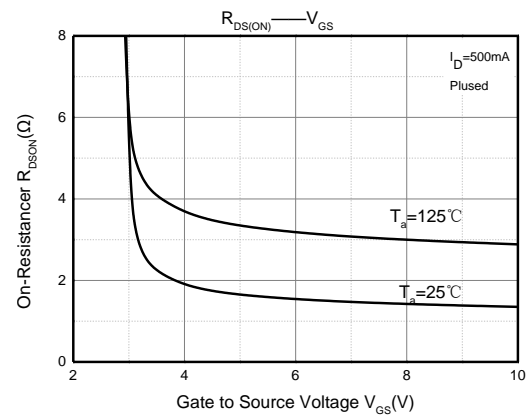
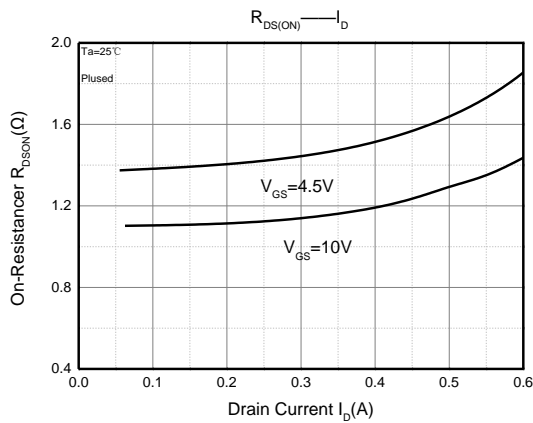
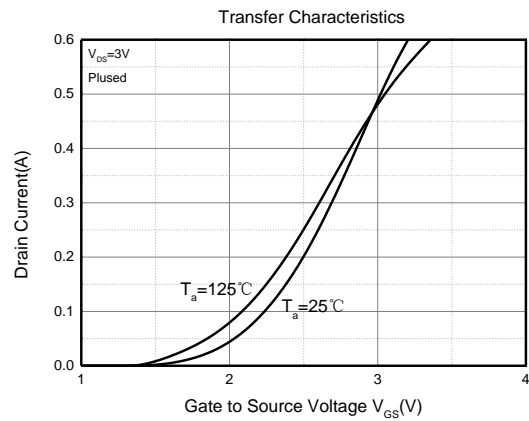
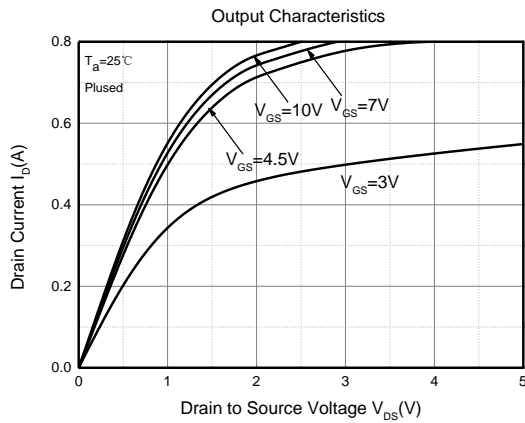
**MOSFET ELECTRICAL CHARACTERISTICS(T<sub>a</sub>=25°C unless otherwise noted)**

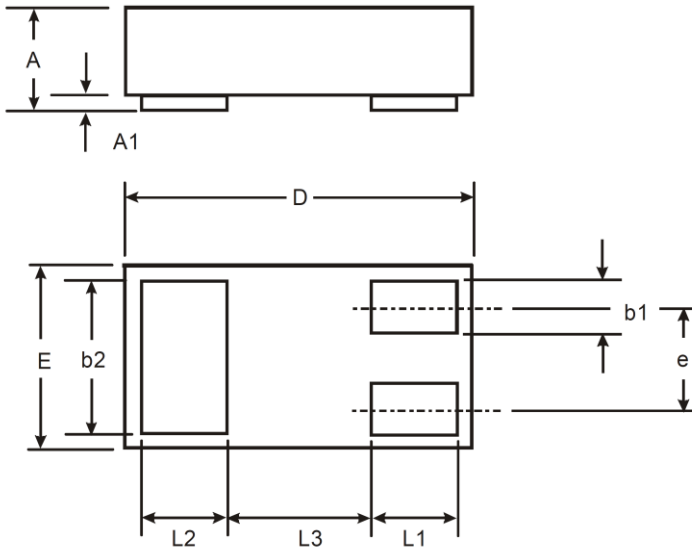
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	60			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V			100	nA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±10	μA
		V <sub>GS</sub> = ±5V, V <sub>DS</sub> = 0V			±1	
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	1.0	1.4	2.5	V
Drain-source on-resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 40mA		1.2	1.5	Ω
		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 35mA		1.3	1.8	
Forward tranconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 40mA	100			mS
Diode forward voltage	V <sub>SD</sub>	V <sub>DS</sub> = 0V, I <sub>S</sub> = 300mA		0.84	1.1	V
<b>Dynamic characteristics</b>						
Input Capacitance <sup>b</sup>	C <sub>iss</sub>	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V, f = 1MHz		41	80	pF
Output Capacitance <sup>b</sup>	C <sub>oss</sub>			3.6	7	
Reverse Transfer Capacitance <sup>b</sup>	C <sub>rss</sub>			2.9	5.6	
Gate resistance	R <sub>g</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1MHz		81	200	Ω
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> = 4.5V	V <sub>DS</sub> = 50V, I <sub>D</sub> = 1A	0.72	1.5	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10V		1.41	2.8	
Gate-Drain Charge	Q <sub>gd</sub>			0.24	0.4	
Turn-on delay time <sup>b</sup>	t <sub>d(on)</sub>				0.24	
Turn-on rise time <sup>b</sup>	t <sub>r</sub>	V <sub>DS</sub> = 50V, I <sub>D</sub> = 1A, V <sub>GS</sub> = 10V, R <sub>G</sub> = 6Ω		3.98	10	ns
Turn-off delay time <sup>b</sup>	t <sub>d(off)</sub>			4.95	10	
Turn-off fall time <sup>b</sup>	t <sub>f</sub>			18.52	40	
Turn-off fall time <sup>b</sup>	t <sub>f</sub>			11.94	25	

**Notes:**

- a. Pulse Test : Pulse width ≤ 300μs, duty cycle ≤ 2%.  
b. These parameters have no way to verify.

## Typical Electrical and Thermal Characteristics





X1-DFN1006-3			
Dim	Min	Max	Typ
<b>A</b>	0.47	0.53	0.50
<b>A1</b>	0	0.05	0.03
<b>b1</b>	0.10	0.20	0.15
<b>b2</b>	0.45	0.55	0.50
<b>D</b>	0.95	1.075	1.00
<b>E</b>	0.55	0.675	0.60
<b>e</b>	—	—	0.35
<b>L1</b>	0.20	0.30	0.25
<b>L2</b>	0.20	0.30	0.25
<b>L3</b>	—	—	0.40
<b>All Dimensions in mm</b>			